

N-Channel MOSFET

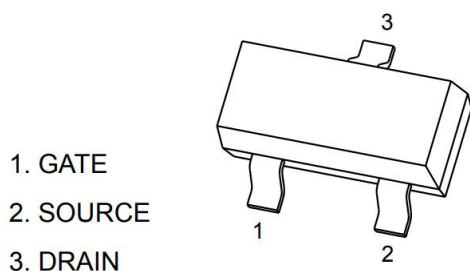
Product Summary

- V_{DS} 100 V
- I_{DS} ($V_{GS}=10V$) 3.0 A
- $R_{DS(ON)}$ ($V_{GS}=10V$) $\leq 85m\Omega$

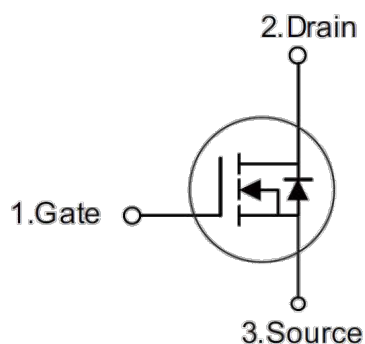
Application

- Interfacing Switching
- Load Switch
- Portable equipment and battery

Package and Pin Configuration



Circuit diagram



SOT-23-3L

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current TA=25°C		I _D	3.0	A
Continuous Drain Current TA=70°C		I _D	2.4	A
Pulsed Drain Current (t = 100 μs)		I _{DM}	20	A
Maximum Power Dissipation	TA=25°C	P _D	1.4	W
	TA=70°C		0.8	W
Operating Junction Temperature Range		T _J	-55 to +150	°C
Storage Temperature Range		T _{stg}	-55 to +150	°C

Thermal Characteristic

PARAMETER	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient($t \leq 10s$)	$R_{\theta JA}$	90	$^\circ C/W$

Note : When mounted on 1" square PCB (FR4 material).



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Electrical Characteristics (T_A=25 °C unless otherwise noted)

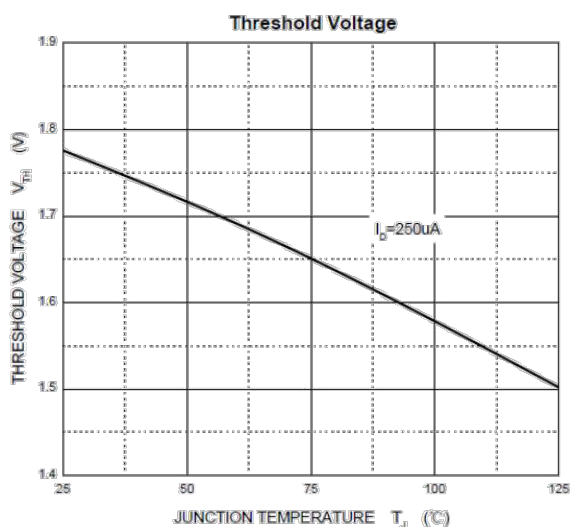
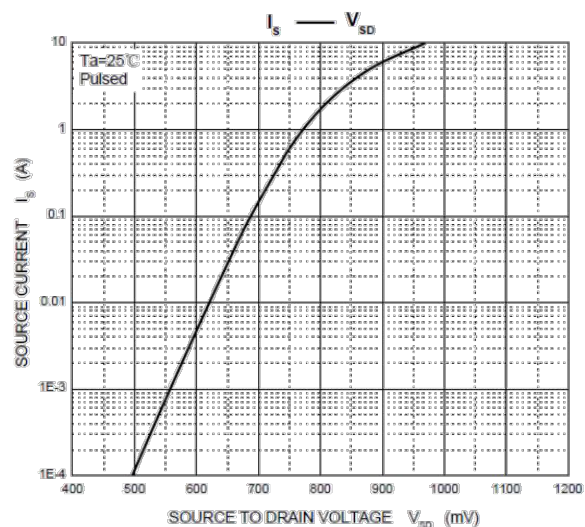
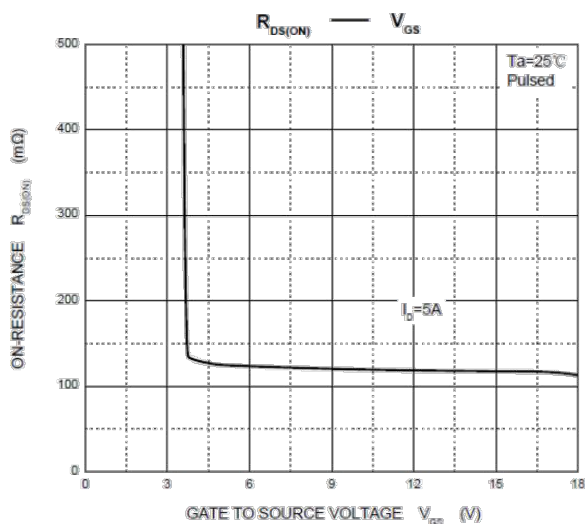
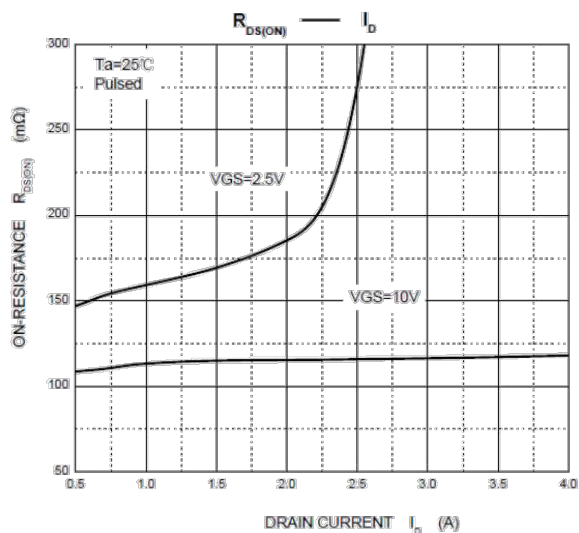
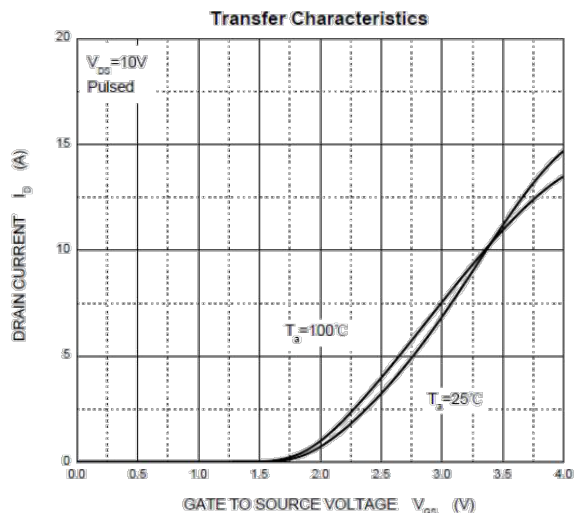
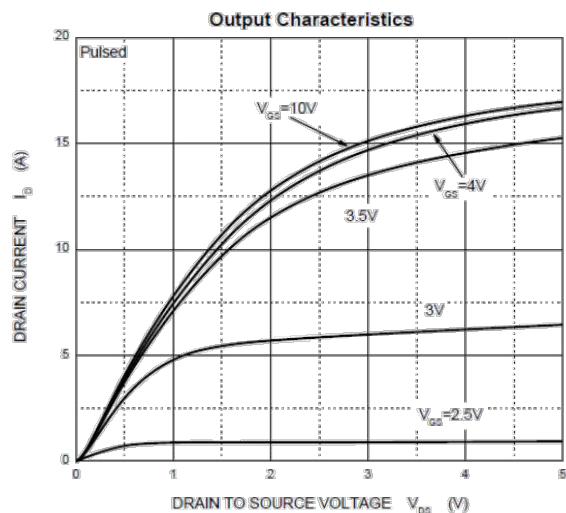
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = 10μA	BV _{DSS}	100	--	--	V
Gate-Source Threshold Voltage	V _{DS} =V _{GS} , I _D = 250μA	V _{GS(th)}	1.3	1.8	2.4	V
Gate-Source Leakage	V _{DS} =0V, V _{GS} = ±20V	I _{GSS}	--	--	±100	nA
Zero Gate Voltage Drain Current	V _{DS} = 120V, V _{GS} =0V	I _{DSS}	--	--	1.0	μA
Drain-Source On-State Resistance (Note 1)	V _{GS} = 10V, I _D = 3.0A	R _{DS(on)}	--	67	85	mΩ
	V _{GS} = 4.5V, I _D = 1.5A		--	85	105	
Forward Transconductance (Note 2)	V _{DS} = 5V, I _D = 1.0A	g _{fs}	--	32	--	S
Dynamic (Note 2)						
Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, F= 1.0MHz	C _{iss}	--	690	--	pF
Output Capacitance		C _{oss}	--	120	--	
Reverse Transfer Capacitance		C _{rss}	--	90	--	
Switching						
Turn-On Delay Time (Note 3)	V _{DS} = 30V, V _{GS} = 10V, I _D = 2A, R _G = 2.5Ω.	t _{d(on)}	--	11	--	nS
Rise Time (Note 3)		t _r	--	7.4	--	
Turn-Off Delay Time (Note 3)		t _{d(off)}	--	35	--	
Fall Time (Note 3)		t _f	--	9.1	--	
Total Gate Charge	V _{DS} = 30V, I _D = 3A, V _{GS} = 10V	Q _g	--	16	--	nC
Gate Source Charge		Q _{gs}	--	3.2	--	
Gate Drain Charge		Q _{gd}	--	4.7	--	
Source-Drain Diode Ratings and Characteristics (Note 2)						
Forward Voltage	V _{GS} = 0V, I _F = 1A	V _{SD}	--	0.8	1.2	V
Continuous Source Current	Integral reverse diode in the MOSFET	I _S	--	--	3.0	A
Pulsed Current (Note 1)		I _{SM}	--	--	20	A

Notes:

1. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
2. Guaranteed by design, not subject to production testing.
3. Independent of operating temperature

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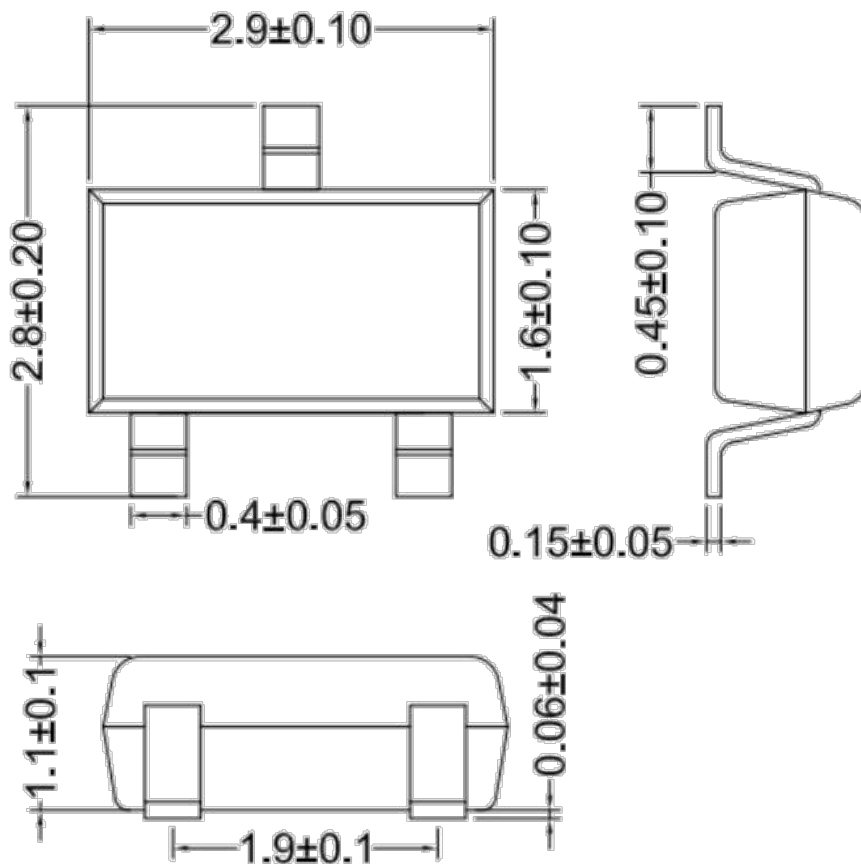
TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)



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Package Outline Dimensions (unit: mm)

SOT-23-3L



Mounting Pad Layout (unit: mm)

